

N-Channel Reduced Q_g, Fast Switching MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)	
100	$0.112 \text{ at V}_{GS} = 10 \text{ V}$	5	
	0.18 at V _{GS} = 4.5 V	4	

FEATURES

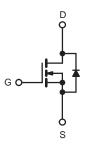
- DT-Trench Power MOSFET
- 175 °C Maximum Junction Temperature











N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T	A = 25 °C, unles	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	100		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current (T _{.I} = 175 °C) ^a	$T_A = 25 ^{\circ}C$	I _D	5.0	4.0	
Continuous Drain Current (1 j = 175 °C)	T _A = 70 °C		4.1	3.0	Α
Pulsed Drain Current		I _{DM}	22		A
Avalanche Current		I _{AS}	12		
Single Pulse Avalanche Energy		E _{AS}	11		mJ
Maximum Dawar Dissination	T _A = 25 °C	- P _D	3.0	1.6	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.0	1.1	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana la sation to Ambient 3	t ≤ 10 s	- R _{thJA}	36	45	°C/W
Maximum Junction-to-Ambient ^a	Steady State		75	90	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	20	

a. Surface Mounted on 1" x 1" FR4 board.



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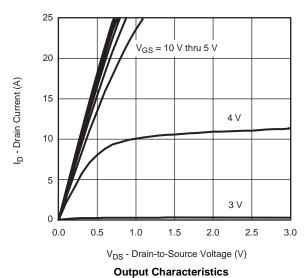
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			V	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3		
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА	
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	22			Α	
		$V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}$		0.112	0.138	Ω	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}, T_J = 125 ^{\circ}\text{C}$		0.168	0.199		
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}, T_J = 175 \text{ °C}$		0.189	0.236		
		$V_{GS} = 4.5 \text{ V}, I_D = 3.0 \text{ A}$		0.180	0.224		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 6.0 \text{ A}$		12		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 1.7 A, V _{GS} = 0 V		0.8	1.2	V	
Dynamic ^b			•				
Total Gate Charge	Q_g			16	23		
Gate-Source Charge	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 6.0 \text{ A}$		3.4		nC	
Gate-Drain Charge	Q_{gd}			5.3			
Gate Resistance	R_g	V _{GS} = 0.1 V, f = 5 MHz	0.5	1.4	2.4	Ω	
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	V_{DD} = 30 V, R_L = 30 Ω		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		25	50	ns	
Fall Time	t _f			12	24		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 1.7 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}$		50	80		

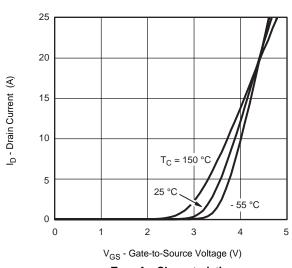
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



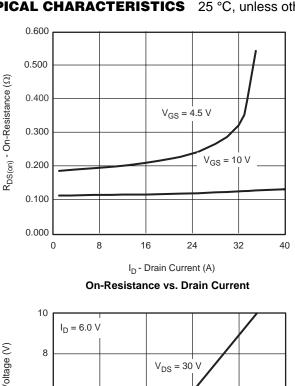


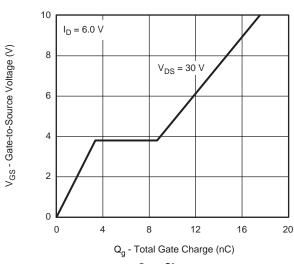


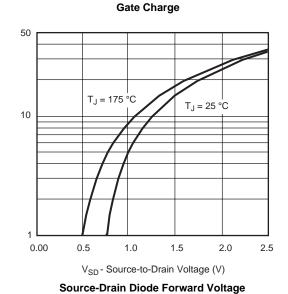
I_S - Source Current (A)

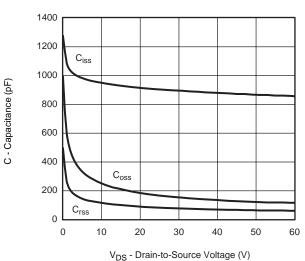
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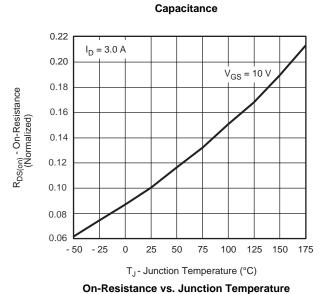
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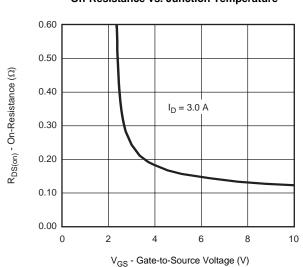










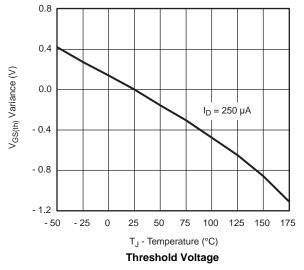


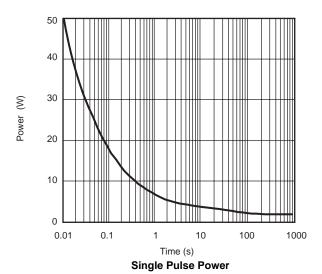
On-Resistance vs. Gate-to-Source Voltage

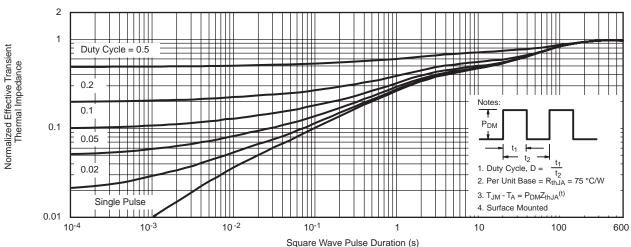


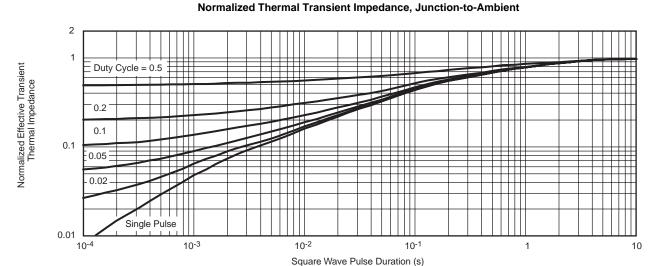


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









Normalized Thermal Transient Impedance, Junction-to-Foot





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